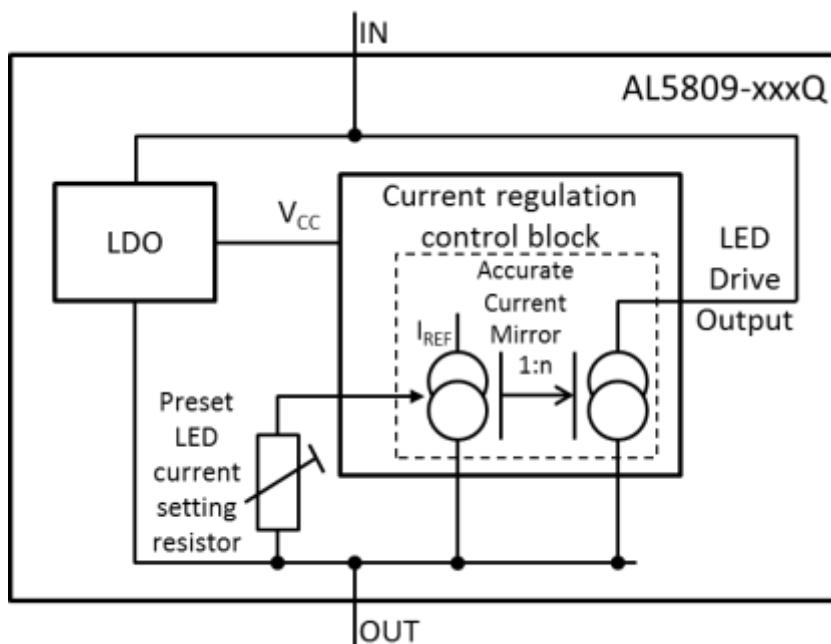


Pin Descriptions

Pin Name	Pin Number (PowerDI123 (Type B))	Function
IN	1	LED Current Input Terminal Current flows IN to this pin. For low-side LED string application, connect the LED cathode terminal to the "IN" terminal. For high-side LED string application, connect the LED anode terminal to the "OUT" terminal.
OUT	2	LED Current Output Terminal Current flows OUT of this pin. For low-side LED string application, connect the LED anode terminal to the "OUT" terminal. For high-side LED string application, connect the LED cathode terminal to the "OUT" terminal.

Functional Block Diagram



Absolute Maximum Ratings

Symbol	Parameter	Rating	Unit
V_{INOUT}	"I" Voltage Relative to "OUT" Pin	80	V
I_{INOUT}	LED Current from "In" to "OUT"	180	mA
ESD HBM	Human Body Model ESD Protection	4,000	V
ESD MM	Machine Model ESD Protection	400	V
ESD CDM	Charged Device Model ESD Protection	1,000	V
T_J	Operating Junction Temperature	-40 to +175	°C
T_{ST}	Storage Temperature	-55 to +150	°C

Caution: Stresses greater than the 'Absolute Maximum Ratings' specified above, may cause permanent damage to the device. These are stress ratings only; functional operation of the device at these or any other conditions exceeding those indicated in this specification is not implied. Device reliability may be affected by exposure to absolute maximum rating conditions for extended periods of time.
Semiconductor devices are ESD sensitive and may be damaged by exposure to ESD events. Suitable ESD precautions should be taken when handling and transporting these devices.

Package Thermal Data

Package	θ_{JC} Thermal Resistance Junction-to-Case	θ_{JA} Thermal Resistance Junction-to-Ambient	P_{DIS} $T_A = +25^\circ\text{C}$, $T_J = +150^\circ\text{C}$
PowerDI123 (Type B)	27.15°C/W	148.6°C/W (Note 5)	0.84W
PowerDI123 (Type B)	17.81°C/W	81.4°C/W (Note 6)	1.53W

Notes: 5. Test condition for PowerDI123 (Type B): Device mounted on 25.4mm x 25.4mm FR-4 PCB (10mm x 10mm 1oz copper, minimum recommended pad layout on top layer and thermal vias to bottom layer ground plane). For better thermal performance, larger copper pad for heatsink is needed.
6. When mounted on 50.8mm x 50.8mm GETEK PCB with 25.4mm x 25.4mm copper pads.

Recommended Operating Conditions (Note 8)

Symbol	Parameter	Min	Max	Unit
V_{INOUT}	"IN" Voltage Range Relative to "OUT" Pin (Notes 7 and 8)	2.5	60	V
I_{INOUT}	LED Current (Note 9)	15	150	mA
$t_{PWM(ON)}$	PWM pulse width in dimming mode on-time	500	—	μs
$t_{PWM(OFF)}$	PWM pulse width in dimming mode on-time	500	—	
T_J	Operating Junction Temperature Range (Note 8)	-40	+150	°C
T_A	Operating Ambient Temperature Range AEC-Q100 Grade 3 (Note 8)	-40	+85	°C
T_A	Operating Ambient Temperature Range AEC-Q100 Grade 1 (Note 8)	-40	+125	°C

Electrical Characteristics ($V_{INOUT} = 3.5V$) (@ $T_A = +25^\circ C$, unless otherwise specified.) (Note 8)

Symbol	Parameter	Condition		Min	Typ	Max	Unit
V_{INOUT}	In-Out Supply Voltage	(Notes 7 and 8)	$T_J = -40^\circ C$ to $+150^\circ C$	2.5	—	60	V
I_{INOUT}	I_{INOUT} Current Accuracy	AL5809-15QP1-7	$T_J = +25^\circ C$	14.25	15	15.75	mA
			$T_J = -40^\circ C$ to $+150^\circ C$	12.8	—	17.3	
		AL5809-20QP1-7	$T_J = +25^\circ C$	19	20	21	
			$T_J = -40^\circ C$ to $+150^\circ C$	17	—	23	
		AL5809-25QP1-7	$T_J = +25^\circ C$	23.75	25	26.25	
			$T_J = -40^\circ C$ to $+150^\circ C$	21.4	—	28.6	
		AL5809-30QP1-7	$T_J = +25^\circ C$	28.5	30	31.5	
			$T_J = -40^\circ C$ to $+150^\circ C$	25.8	—	34.2	
		AL5809-40QP1-7	$T_J = +25^\circ C$	38	40	42	
			$T_J = -40^\circ C$ to $+150^\circ C$	34.6	—	45.4	
		AL5809-50QP1-7	$T_J = +25^\circ C$	47.5	50	52.5	
			$T_J = -40^\circ C$ to $+150^\circ C$	44	—	56	
		AL5809-60QP1-7	$T_J = +25^\circ C$	57	60	63	
			$T_J = -40^\circ C$ to $+150^\circ C$	54	—	66	
		AL5809-90QP1-7	$T_J = +25^\circ C$	85.5	90	94.5	
			$T_J = -40^\circ C$ to $+150^\circ C$	81	—	99	
		AL5809-100QP1-7	$T_J = +25^\circ C$	95	100	105	
			$T_J = -40^\circ C$ to $+150^\circ C$	90	—	110	
		AL5809-120QP1-7	$T_J = +25^\circ C$	114	120	126	
			$T_J = -40^\circ C$ to $+150^\circ C$	108	—	132	
		AL5809-150QP1-7	$T_J = +25^\circ C$	142.5	150	157.5	
			$T_J = -40^\circ C$ to $+150^\circ C$	135	—	165	
I_{LINE}	I_{INOUT} Current Line Regulation	$V_{INOUT} = 2.5V$ to $60V$ (Note 10)	$T_A = +25^\circ C$	—	1	—	%/V
V_{MIN}	Minimum Power Up Voltage	Increase V_{INOUT} (Note 11)	$T_J = -40^\circ C$ to $+150^\circ C$	1	1.5	2	V
T_{SHDN}	Thermal Shutdown Junction Temperature	—	—	—	+165	—	$^\circ C$
T_{HYS}	Thermal Shutdown Hysteresis	—	—	—	+30	—	$^\circ C$

- Notes:
- All voltages unless otherwise stated are measured with respect to the OUT Pin.
 - Subject to maximum junction temperature of $+150^\circ C$ not being exceeded. The Maximum ambient temperature range is limited by device power dissipation; such that its junction temperature should be kept less than or equal to $+150^\circ C$. See Page 5 for more information on power dissipation. Devices have been qualified to AEC-Q100 Grade 3 and Grade 1.
 - The LED operating current is determined by the AL5809Q current option index XXX, AL5809Q-XXXP1-7.
 - Measured percentage change of LED current variation when V_{INOUT} varies from 2.5V to 60V for each current option.
 - Apply the power linearly to the chip until the device starts to turn on.

Application Information

Description

The AL5809Q is a constant current linear LED driver that can be connected on the high side or low side of the LEDs as a Constant Current Regulator (CCR). The AL5809Q is available in various output current options from 15mA up to 150mA.

The AL5809Q contains a Low Dropout regulator which provides power to the internal current regulation control block. A fixed preset LED current setting resistor sets the reference current of the current regulation block. The LED current setting resistor varies with each variant of the AL5809. An accurate current mirror within the current regulation control block then increases the reference current to the preset LED current of the AL5809Q.

Simple LED String

The number of LEDs that the AL5809Q can drive depends on the forward voltage drop of the LEDs and the input supply voltage (minus the minimum operating voltage of the AL5809Q). The designer needs to calculate the maximum voltage between In and Out by taking into account the maximum input voltage less the voltage across the LED string (Figures 1 & 2).

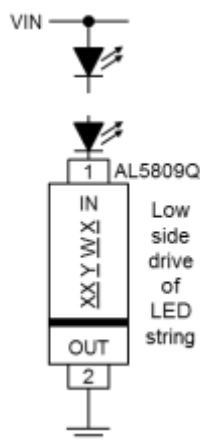


Figure 1 Low-Side LED String Drive

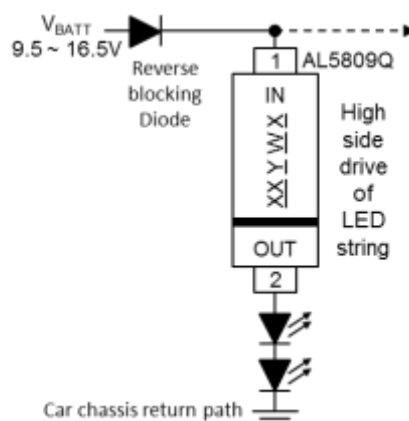
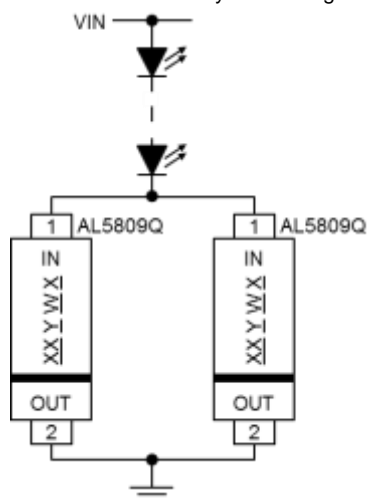


Figure 2 High-Side LED String Drive

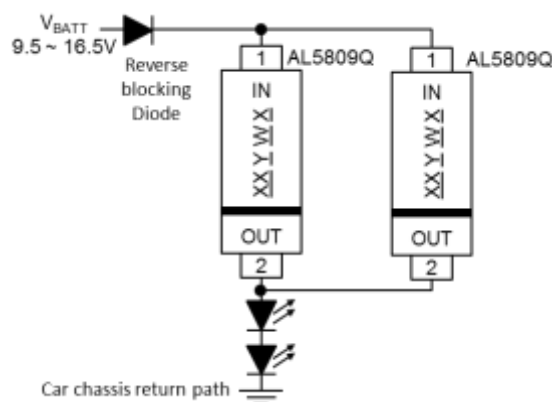
The AL5809Q can also be used on the high-side of the LEDs (See Figure 2). The minimum system input voltage can be calculated by:

$$V_{IN(MIN)} = V_{LED_CHAIN} + 2.5V \quad \text{Where } V_{LED_CHAIN} \text{ is the LED chain voltage and } 2.5V \text{ is the minimum } V_{IO(OUT)} \text{ voltage of the AL5809Q.}$$

The LED current can be increased by connecting two or more AL5809Q in parallel shown in Figure 3.



(a) Low-Side Configuration



(b) High-Side Configuration

Figure 3 Higher LED Current by Parallel Configuration of AL5809Q

Application Information (Continued)

Power Dissipation

The maximum ambient temperature range of the AL5809Q is determined by its power dissipation and thermal impedance of the PCB onto which it is mounted. Its junction temperature must be kept equal to or less than +150°C.

The power dissipated is determined by the LED current version that has been selected (15, 20, 25, 30, 40, 50, 60, 90, 100, 120 or 150mA) and the difference between the input voltage and LED chain voltage.

$$V_{INOUT} * I_{LED}$$

In automotive applications the typical input voltage will be around 13V but can vary between 9V (without stop-start operation) and approximately 16V.

The recommended minimum V_{INOUT} voltage of 2.5V enables the AL5809Q to drive 2 LED in series from the 9V battery voltage (assuming $V_{LED} < 3.25V$).

The AL5809Q's power dissipation under these conditions will be:

$$V_{INOUT} * I_{LED} = 2.5 * I_{LED}$$

So for the 20mA AL5809-20QPI under these conditions this equals:

$$2.5V * 20mA = 50mW$$

Under maximum input conditions (16V) the AL5809Q's power dissipation will be:

$$V_{INOUT} * I_{LED} = 9.5 * I_{LED}$$

So for the 20mA AL5809-20QPI this equals:

$$9.5V * 20mA = 190mW$$

So there is a large difference in power dissipation of the Linear LED driver between minimum and maximum battery voltages. And care must be taken to calculate expected power dissipations and then determining the suitable PCB material and layout. See Figures 4 and 5 for graphs showing power dissipation and maximum V_{INOUT} , for different currents and PCB material. Maximizing the area and mass of the ground plane with additional vias between the pad of the Out Pin will improve the thermal impedance (θ_{JA}) of the AL5809Q.

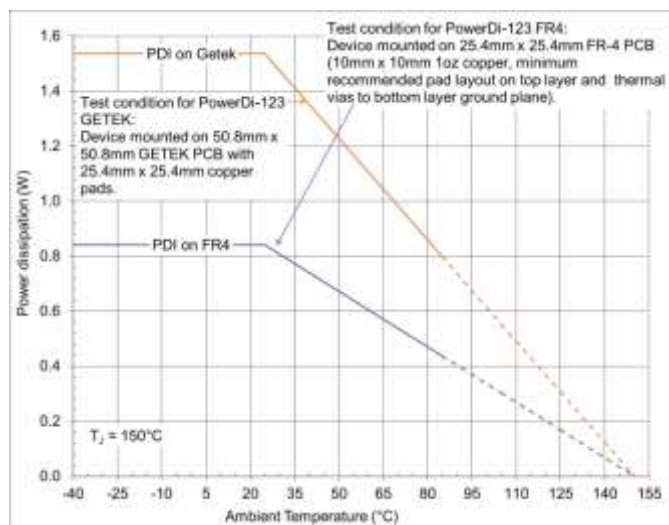


Figure 4 Power Dissipation vs. Ambient Temperature @ $T_J = +150^\circ C$

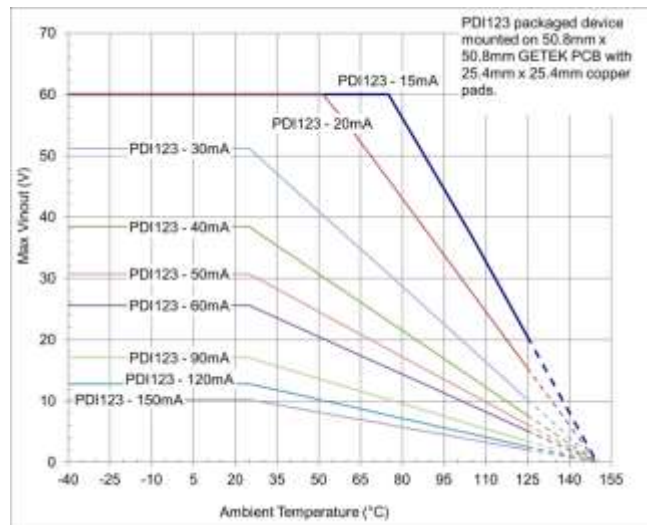
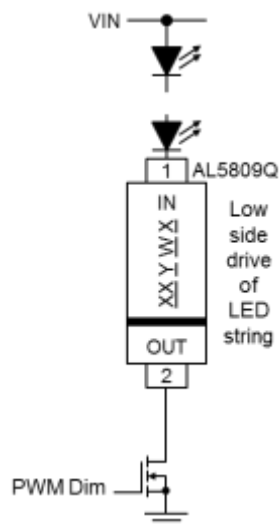


Figure 5 Maximum V_{INOUT} vs. Ambient Temperature @ $T_J = +150^\circ C$

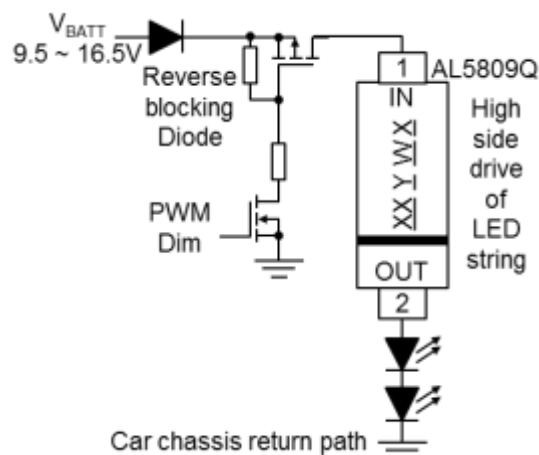
Application Information (Cont.)

PWM Dimming

The AL5809Q can be used to provide LED current dimming driving the Out Pin via an external MOSFET switch to Ground (Figure 6a) for high-side connected LEDs or a high-side switch for Ground-connected LEDs. The Out Pin current is then effectively switched on and off causing the LED current to turn on and off. The dimming effect can be achieved by varying the PWM signal duty cycle.



a) PWM Dimming by External MOSFET



b) PWM Dimming by Power Supply VIN ON/OFF

Figure 6 PWM Dimming

Recommended PWM Frequency and Dimming Range

PWM Frequency (Hz)	Duty Cycle (%)	
	Minimum	Maximum
100	5	95
200	10	90

Test conditions (Figure 6a): PWM frequency 100Hz–200Hz Square wave, 0–4V gate voltage, $V_{IN} = 6V$, 1 LED, AL5809–30mA

Use the following formulae to calculate the Min and Max duty cycle:

$$\text{Min. Duty cycle (\%)} = \frac{t_{ON_MIN}}{\text{PWM signal Time period}}$$

$$\text{Max. Duty cycle (\%)} = 100\% - \frac{t_{OFF_MIN}}{\text{PWM signal Time period}}$$

Notes: $t_{ON_MIN} = 500\mu s$ (Min. value), and $t_{OFF_MIN} = 500\mu s$ (Min. value) as listed in the Recommended Operating Conditions – see also Figure 7.

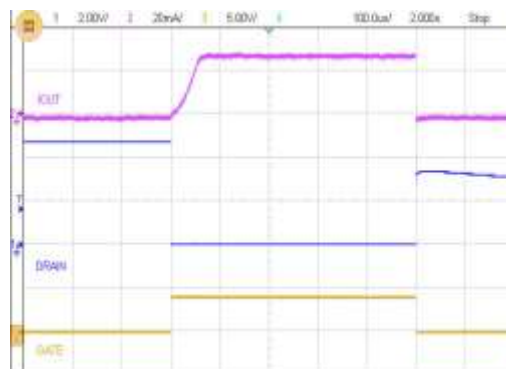


Figure 7 Minimum On Pulse Width (t_{ON_MIN})

PWM Dimming Performance



Figure 8 PWM Dimming 30mA vs. Duty Cycle

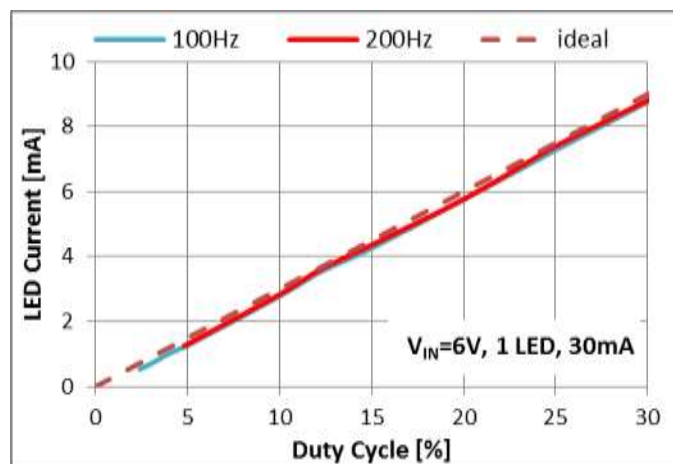


Figure 9 Low Duty Cycle Zoomed-in of Figure 7

Typical Performance Characteristics (15mA, 20mA, 30mA, 40mA, 50mA Options)

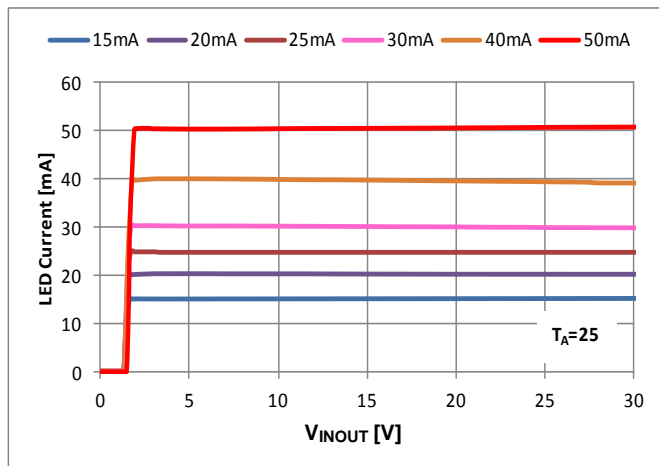


Figure 10 LED Current vs. V_{INOUT}

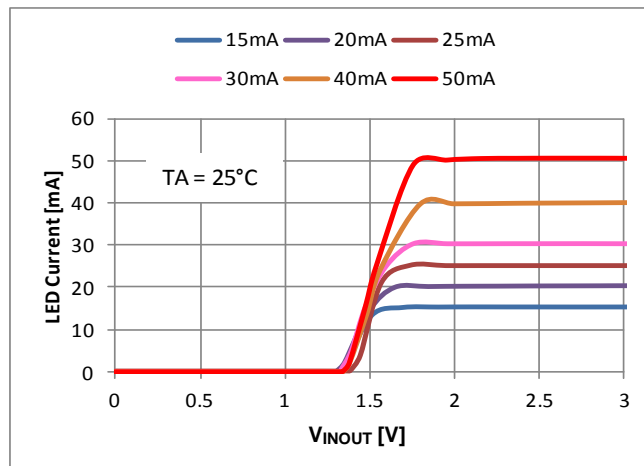


Figure 11 Startup Minimum Operating Voltage

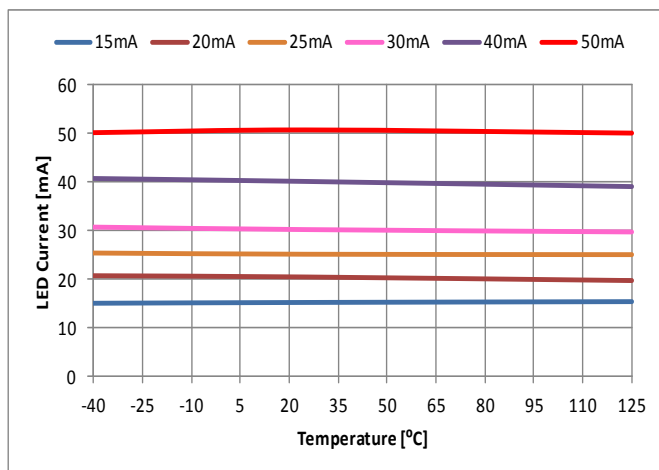


Figure 12 LED Current vs. Ambient Temperature

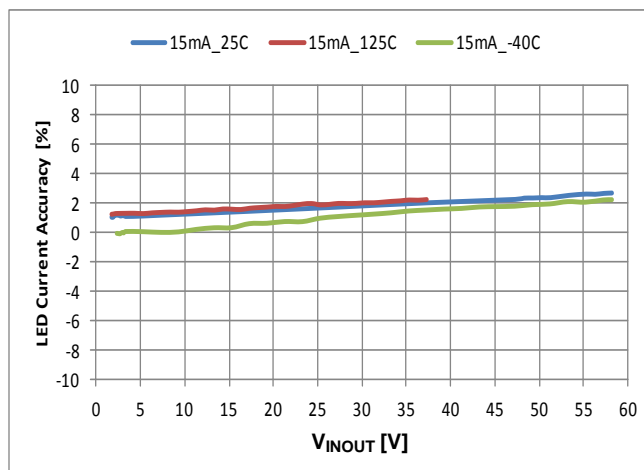


Figure 13 LED Current Accuracy (%) vs. Across Temperature

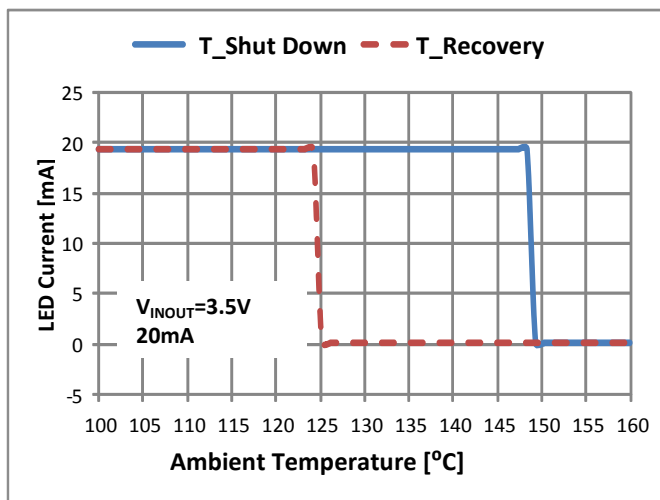


Figure 14 THSD of 20mA Current Option

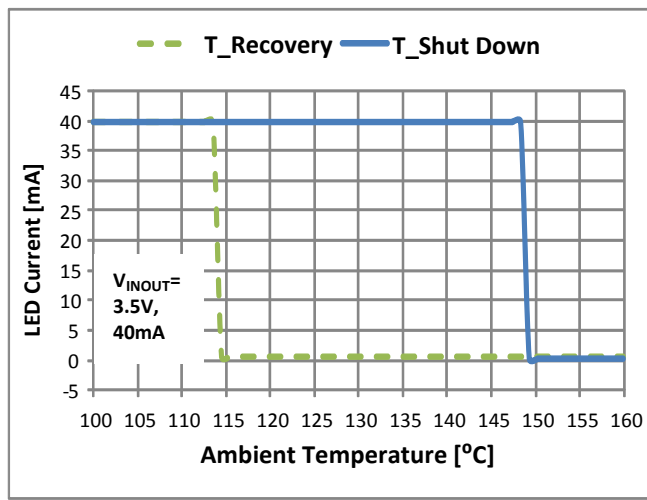


Figure 15 THSD of 40mA Current Option

Typical Performance Characteristics (Continued) (60mA, 90mA, 150mA Options)

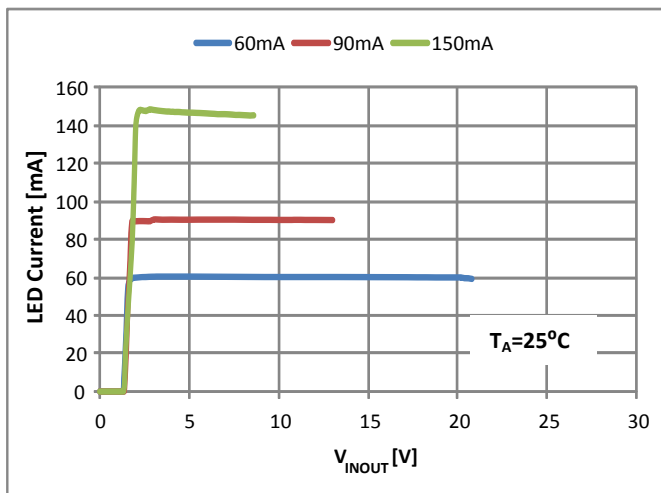


Figure 16 LED Current vs. V_{INOUT}

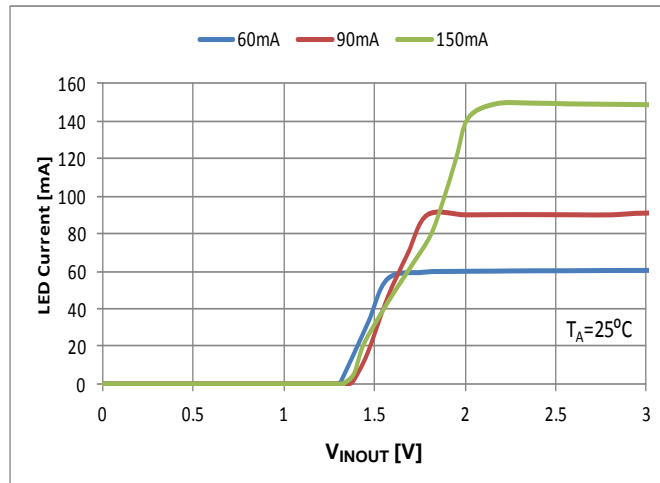


Figure 17 Startup Minimum Operating Voltage

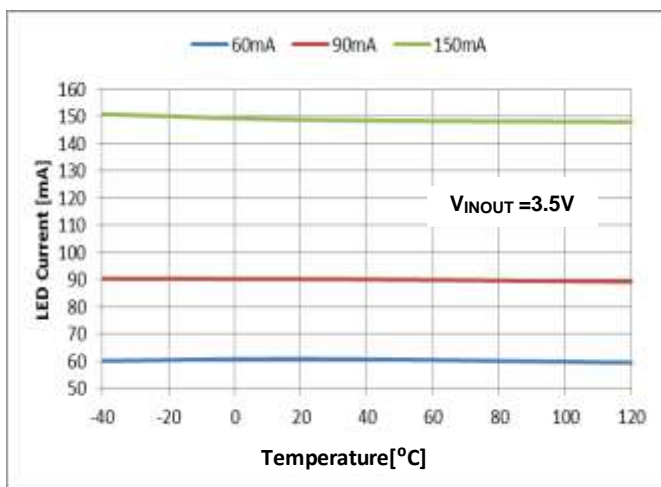


Figure 18 LED Current across Temperature

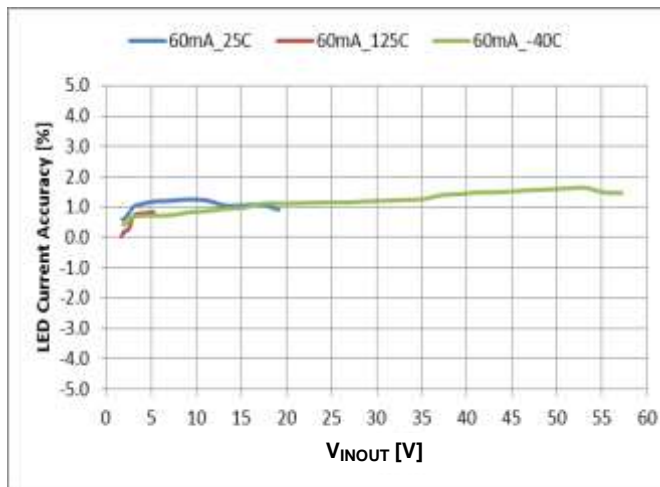


Figure 19 LED Current Accuracy (%) vs. V_{INOUT} across Temperature

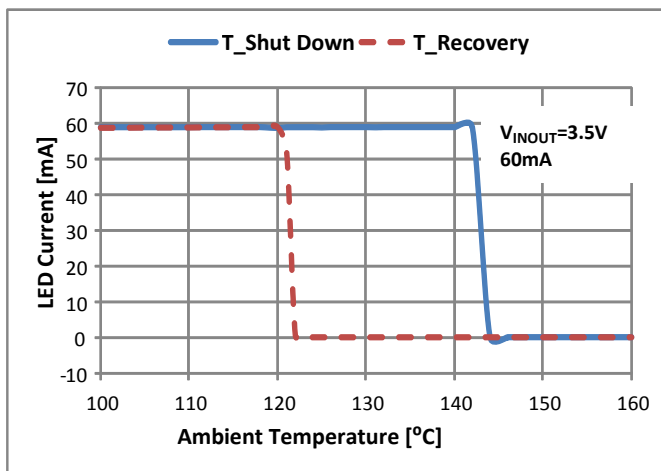


Figure 20 THSD of 60mA Current Option

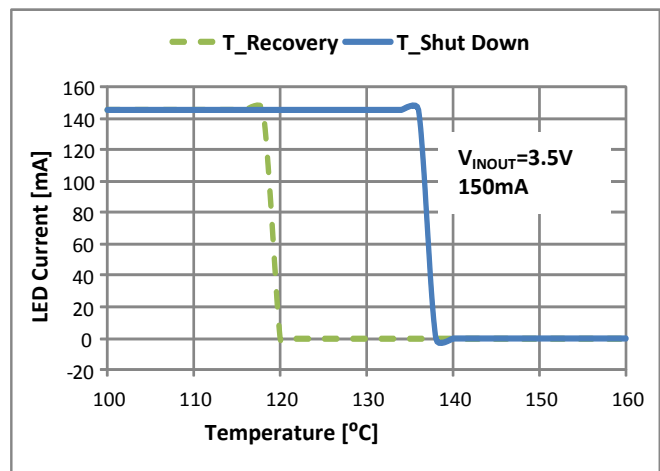
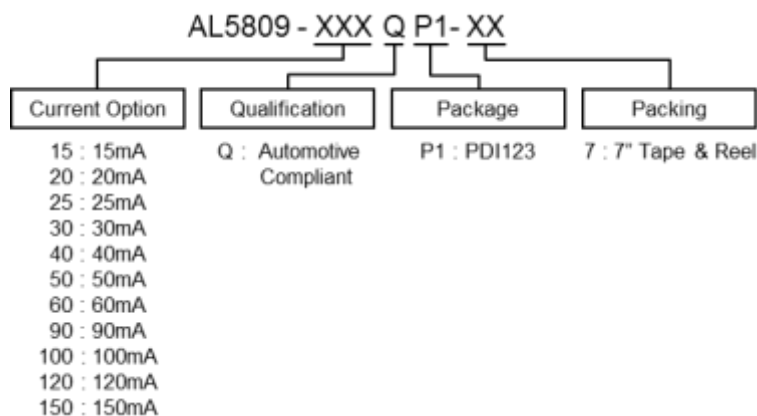


Figure 21 THSD of 150mA Current Option

Ordering Information (Note 12)

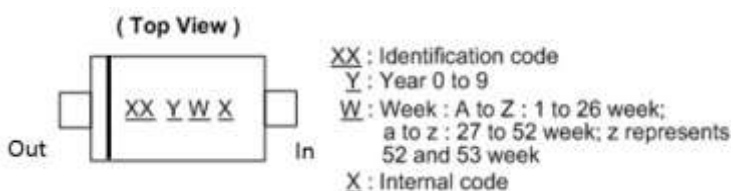


Part Number	LED Current Option	Package Code	Packaging	7" Tape and Reel		Qualification (Note 13)
				Quantity	Part Number Suffix	
AL5809-15QP1-7	15mA	P1	PowerDI123 (Type B)	3,000	-7	Automotive Compliant
AL5809-20QP1-7	20mA	P1	PowerDI123 (Type B)	3,000	-7	Automotive Compliant
AL5809-25QP1-7	25mA	P1	PowerDI123 (Type B)	3,000	-7	Automotive Compliant
AL5809-30QP1-7	30mA	P1	PowerDI123 (Type B)	3,000	-7	Automotive Compliant
AL5809-40QP1-7	40mA	P1	PowerDI123 (Type B)	3,000	-7	Automotive Compliant
AL5809-50QP1-7	50mA	P1	PowerDI123 (Type B)	3,000	-7	Automotive Compliant
AL5809-60QP1-7	60mA	P1	PowerDI123 (Type B)	3,000	-7	Automotive Compliant
AL5809-90QP1-7	90mA	P1	PowerDI123 (Type B)	3,000	-7	Automotive Compliant
AL5809-100QP1-7	100mA	P1	PowerDI123 (Type B)	3,000	-7	Automotive Compliant
AL5809-120QP1-7	120mA	P1	PowerDI123 (Type B)	3,000	-7	Automotive Compliant
AL5809-150QP1-7	150mA	P1	PowerDI123 (Type B)	3,000	-7	Automotive Compliant

- Notes:
- For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.
 - AL5809Q has been qualified to AEC-Q100 and is classified as "Automotive Compliant" supporting PPAP documentation. 60mA, 90mA, 100mA, 120mA and 150mA versions have been qualified to AEC-Q100 Grade 3. 15mA, 20mA, 25mA, 30mA, 40mA and 50mA have been qualified to AEC-Q100 Grade 1. See AL5809 datasheet for commercial qualified versions.

Marking Information

PowerDI123 (Type B)

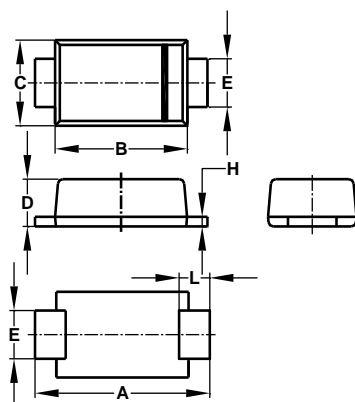


Part Number	Identification Code
AL5809-15QP1-7	C1
AL5809-20QP1-7	C2
AL5809-25QP1-7	CA
AL5809-30QP1-7	C3
AL5809-40QP1-7	C4
AL5809-50QP1-7	C5
AL5809-60QP1-7	C6
AL5809-90QP1-7	C7
AL5809-100QP1-7	CB
AL5809-120QP1-7	C8
AL5809-150QP1-7	C9

Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

PowerDI123 (Type B)

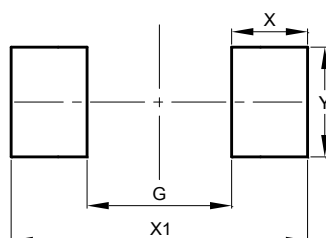


PowerDI123 (Type B)			
Dim	Min	Max	Typ
A	3.50	3.90	3.70
B	2.60	3.00	2.80
C	1.63	1.93	1.78
D	0.93	1.00	0.98
E	0.85	1.25	1.00
H	0.15	0.25	0.20
L	0.50	0.80	0.65
All Dimensions in mm			

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

PowerDI123 (Type B)

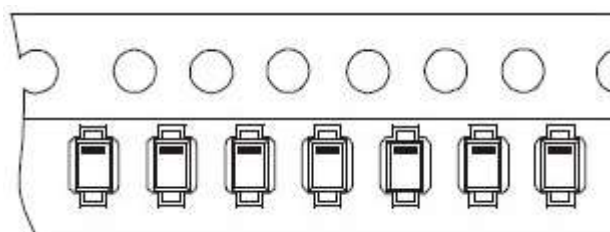


Dimensions	Value (in mm)
G	2.000
X	1.050
X1	4.100
Y	1.500

Taping Orientation

The taping orientation of the other package type can be found on our website at <https://www.diodes.com/assets/Datasheets/ap02007.pdf>.

PowerDI123 (Type B)



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